

N-Channel 60 V (D-S) MOSFET

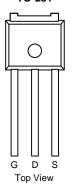
PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	Q _g (Typ.)		
60	$0.032 \text{ at V}_{GS} = 10 \text{ V}$	35 ^d	21.7		
60	0.037 at $V_{GS} = 4.5 \text{ V}$	30 ^d	21.7		

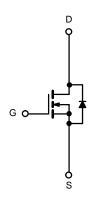
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R_g and UIS Tested
 Compliant to RoHS Directive 2002/95/EC









N-Channel MOSFET

APPLICATIONS

- Power Supply
 - Secondary Synchronous Rectification
- DC/DC Converter

ABSOLUTE MAXIMUM RATINGS T _C = 25 °C, unless otherwise noted						
Parameter	Symbol	Limit	Unit			
Drain-Source Voltage	V _{DS}	60	V			
Gate-Source Voltage	V _{GS}	± 20	V			
Continuous Drain Current (T _{.I} = 150 °C)	T _C = 25 °C	I _D	35 ^d	A		
Continuous Brain Current (1) = 130 O)	T _C = 70 °C	טי	30 ^d			
Pulsed Drain Current	I _{DM}	100				
Avalanche Current	I _{AS}	40				
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	80	mJ		
Mariana Barran Bissin etiani	T _C = 25 °C	P _D	59.5 ^b	W		
Maximum Power Dissipation ^a	T _A = 25 °C ^c	'-D	2.7] VV		
Operating Junction and Storage Temperature Ra	nge	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS					
Parameter	Symbol	Limit	Unit		
Junction-to-Ambient (PCB Mount) ^c	R _{thJA}	46	°C/W		
Junction-to-Case (Drain)	R _{thJC}	2.1	C/VV		

Notes:

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.c. When mounted on 1" square PCB (FR-4 material).
- d. Package limited.



SPECIFICATIONS $T_J = 25^{\circ}$	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	Oyillooi	rest conditions	141111-	Typ.	IVIQA.	Onic	
Drain-Source Breakdown Voltage	V _{DS}	V _{DS} = 0 V, I _D = 250 μA	60				
Gate Threshold Voltage	1	$V_{DS} = V_{SS}, I_{D} = 250 \mu\text{A}$ $V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	2.0		3.5	V	
Gate-Body Leakage	V _{GS(th)}	$V_{DS} = V_{GS}, V_{GS} = \pm 20 \text{ V}$	2.0		± 250	nA	
Gale-Body Leakage	I _{GSS}	$V_{DS} = 60 \text{ V}, V_{GS} = 20 \text{ V}$ $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$			1	IIA	
Zana Cata Valtana Basis Comment		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 125 \text{ °C}$			50		
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 123 \text{ C}$ $V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 150 \text{ °C}$			250	μA	
On-State Drain Current ^a	1		50		250	Α	
On-State Drain Current	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	50	0.000		A	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 12 A		0.032		Ω	
		$V_{GS} = 4.5 \text{ V}, I_D = 10 \text{ A}$		0.037			
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 10 A		110		S	
Dynamic ^b	<u> </u>		T	<u> </u>			
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 30 V, f = 1 MHz		1100		pF	
Output Capacitance	C _{oss}			281			
Reverse Transfer Capacitance	C _{rss}			130			
Total Gate Charge ^c	Qg	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		46		nC	
Total Cate Gharge				28			
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		7			
Gate-Drain Charge ^c	Q_{gd}			6.7			
Gate Resistance	R_{g}	f = 1 MHz	0.4	2	4	Ω	
Turn-On Delay Time ^c	t _{d(on)}			8	16		
Rise Time ^c	t _r	$V_{DD} = 30 \text{ V, R}_{1} = 1.5 \Omega$		9	18		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		35	53	ns	
Fall Time ^c	t _f			9	18		
Drain-Source Body Diode Ratings a	nd Characteris	stics T _C = 25 °C ^b	L	L			
Continuous Current	I _S				50		
Pulsed Current	I _{SM}				100	A	
Forward Voltage ^a	V _{SD}	I _F = 10 A, V _{GS} = 0 V		0.75	1.5	V	
Reverse Recovery Time	t _{rr}	. 33		34	51	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 10 A, dl/dt = 100 A/μs		2	3	Α	
Reverse Recovery Charge	Q _{rr}			34	51	nC	

Notes:

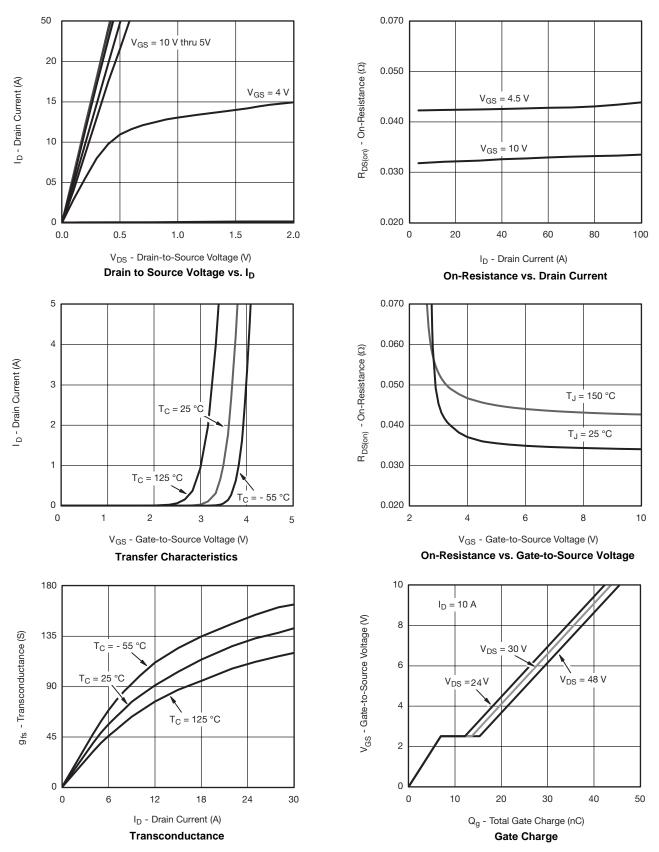
- a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

服务热线:400-655-8788

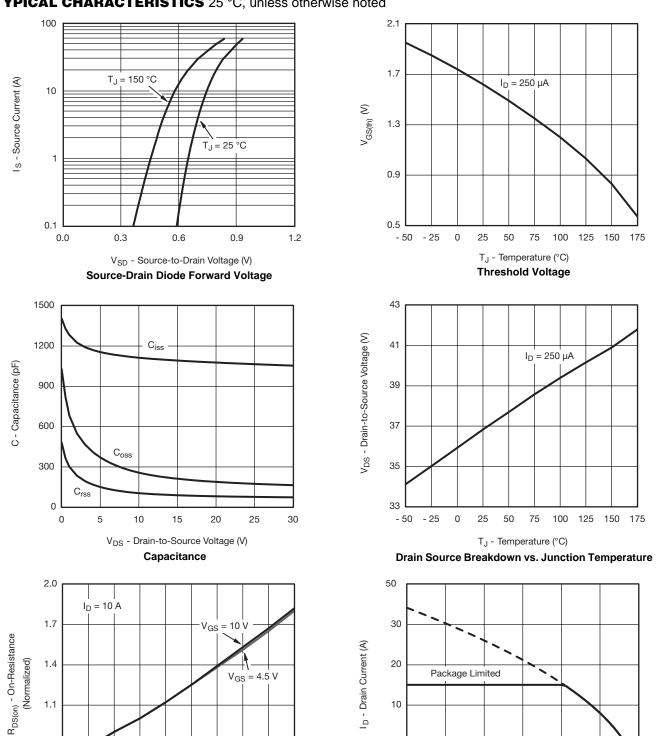


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



05

0

0

25

75

T_C - Case Temperature (°C)

Current Derating

150

0.8

0.5

- 50

50 75

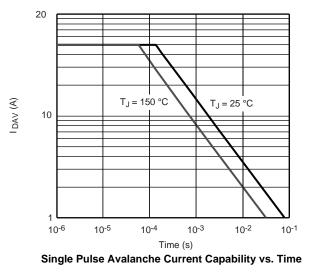
T_J - Junction Temperature (°C)

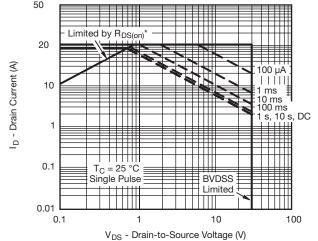
On-Resistance vs. Junction Temperature

100 125 150

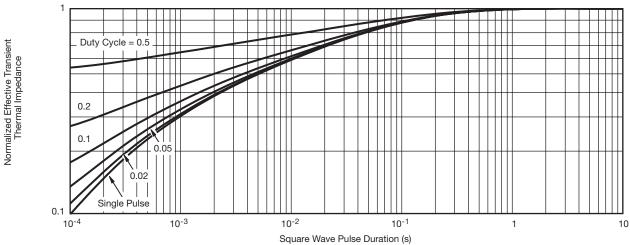


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





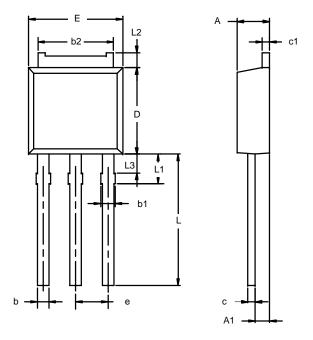
 * V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Case



TO-251AA (DPAK)



	MILLIMETERS I			INCHES	
Dim	Min	Max	Min	Max	
Α	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
b	0.71	0.89	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.43	0.206	0.214	
С	0.46	0.58	0.018	0.023	
с1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
Е	6.48	6.73	0.255	0.265	
е	2.28 BSC		0.090 BSC		
L	8.89	9.53	0.350	0.375	
L1	1.91	2.28	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.045	0.060	
ECN: S-03946—Rev. E, 09-Jul-01 DWG: 5346					

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